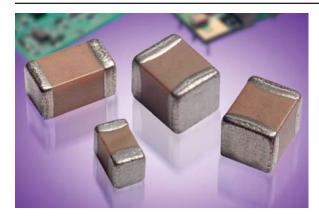
X7S Dielectric



General Specifications



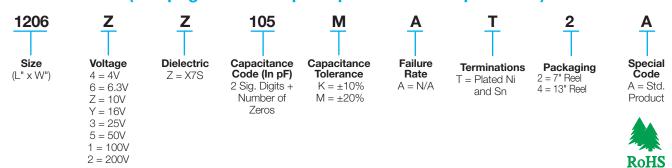
GENERAL DESCRIPTION

X7S formulations are called "temperature stable" ceramics and fall into EIA Class II materials. Its temperature variation of capacitance s within $\pm 22\%$ from -55°C to ± 125 °C. This capacitance change is non-linear.

Capacitance for X7S varies under the influence of electrical operating conditions such as voltage and frequency.

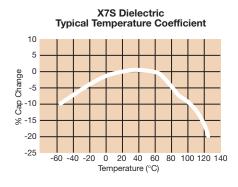
X7S dielectric chip usage covers the broad spectrum of industrial applications where known changes in capacitance due to applied voltages are acceptable.

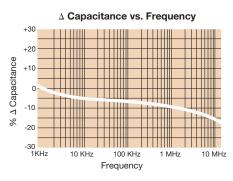
PART NUMBER (see page 2 for complete part number explanation)

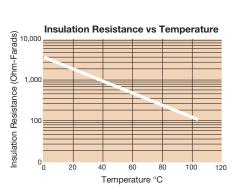


NOTE: Contact factory for availability of Tolerance Options for Specific Part Numbers.

TYPICAL ELECTRICAL CHARACTERISTICS



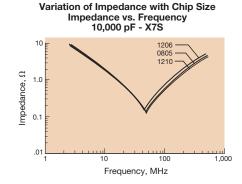


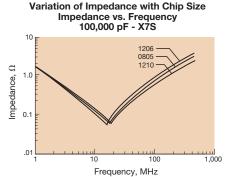


Impedance vs. Frequency 1,000 pF vs. 10,000 pF - X7S 0805

Frequency, MHz

Variation of Impedance with Cap Value





X7S Dielectric



Specifications and Test Methods

	ter/Test	X7S Specification Limits	Measuring Conditions				
Operating Temperature Range		-55°C to +125°C	Temperature C	ycle Chamber			
Capac	itance	Within specified tolerance					
Dissipation Factor		≤ 5.0% for ≥ 100V DC rating	Freq.: 1.0 k				
		≤ 5.0% for ≥ 25V DC rating	Voltage: 1.0Vrms ± .2V				
2.00. 0.00.		≤ 10.0% for ≥ 10V DC rating	For Cap > 10 μF, 0.5Vrms @ 120Hz				
		≤ 10.0% for ≤ 10V DC rating	01 1 1 11				
Insulation	Resistance	100,000MΩ or 1000MΩ - μF,	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity				
		whichever is less	Charge device with 300				
Dielectric	Strength	No breakdown or visual defects	1-5 seconds, w/charge limited to 50	and discharge current 0 mA (max)			
Resistance to	Appearance	No defects	Deflection: 2mm Test Time: 30 seconds				
	Capacitance	≤ ±12%					
	Variation	3 ±12/0	1mm/sec				
Flexure	Dissipation	Meets Initial Values (As Above)	V				
Stresses	Factor	Wideta iriitai valdea (167166ve)	90 mm				
	Insulation	≥ Initial Value x 0.3					
	Resistance						
Solderability		≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic solder at 230 ± 5°C for 5.0 ± 0.5 seconds				
	Appearance	No defects, <25% leaching of either end terminal	101 5.0 ± 0.	5 Seconus			
	Capacitance						
	Variation	≤ ±7.5%					
Resistance to Solder Heat	Dissipation		Dip device in eutectic				
	Factor	Meets Initial Values (As Above)	seconds. Store at room				
	Insulation		hours before measurin	g electrical properties.			
	Resistance	Meets Initial Values (As Above)					
	Dielectric	NA -					
	Strength	Meets Initial Values (As Above)					
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes			
	Capacitance	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes			
	Variation		' '				
Thermal	Dissipation	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes			
Shock	Factor Insulation						
	Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes			
	Dielectric		Repeat for 5 cycles and measure after				
	Strength	Meets Initial Values (As Above)	24 ± 2 hours at room temperature				
	Appearance	No visual defects		'			
	Capacitance	≤ ±12.5%	Charge device with 1.5 rated voltage (≤ 10V) in test chamber set at 125°C ± 2°C				
	Variation	≥ ±12.0/0					
	Dissipation	≤ Initial Value x 2.0 (See Above)	for 1000 hoเ	urs (+48, -0)			
Load Life	Factor	s iritiai vaide x 2.0 (dee Above)		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1			
	Insulation	≥ Initial Value x 0.3 (See Above)	Remove from test chamber and stabilize at room temperature for 24 ± 2 hours before measuring.				
	Resistance						
	Dielectric Strength	Meets Initial Values (As Above)					
	Appearance	No visual defects					
	Capacitance		Store in a test chamber set at 85°C ± 2°C/85% ± 5% relative humidity for 1000 hours				
	Variation	≤ ±12.5%					
Load	Dissipation	1 11 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	(+48, -0) with rate	d voltage applied.			
Load Humidity	Factor	≤ Initial Value x 2.0 (See Above)	Remove from chamber and stabilize at				
	Insulation	> Initial Value v 0.2 (Cas Abaya)					
	Resistance	≥ Initial Value x 0.3 (See Above)	room temperature and humidity for 24 ± 2 hours before measuring.				
	Dielectric	Meets Initial Values (As Above)					
	Strength	IVICETA ILITIAI VAIDES (NO NOVE)					

X7S Dielectric





PREFERRED SIZES ARE SHADED

				E										
SIZE		0402		0603		0805	1206		121	0				
Soldering		Reflow/Way	ve	Reflow/Wave		Reflow/Wave		low/Wav	/e	Reflow Only				
Packaging		All Paper		All Paper	Pape	Paper/Embossed		Paper/Embossed		Paper/Embossed				
(L) Length	mm (in.)	1.00 ± 0.10 (0.040 ± 0.00		1.60 ± 0.15 (0.063 ± 0.006		.01 ± 0.20 .079 ± 0.008)	3.20 ± 0.20 (0.126 ± 0.008)		3.20 ± (0.126 ±					
(W) Width	mm (in.)	0.50 ± 0.10 (0.020 ± 0.00		0.81 ± 0.15 (0.032 ± 0.006	1	.25 ± 0.20)49 ± 0.008)	1.	1.60 ± 0.20 (0.063 ± 0.008)		2.50 ± (0.098 ±	0.20			
(t) Terminal	mm (in.)	0.25 ± 0.15 (0.010 ± 0.00		0.35 ± 0.15 (0.014 ± 0.006	0	.50 ± 0.25)20 ± 0.010)	0.	50 ± 0.25 20 ± 0.01		0.50 ± (0.020 ±	0.25			
	WVDC	6.3		6.3		4	10	50	100	6.3				
Cap	100													
(pF)	150													
	220						Į.	سا.	~>	\sim W	•			
	330						~	<u></u>	<		\ ^+			
	470							(~	~	ヽレ	<i>J</i>			
	680 1000		-		-		+	_	_l _		_			
	1500								$\mathcal{L}_{\mathbf{a}}$					
	2200								*t					
	3300				_		†							
	4700						1 1	1	1	ı				
	6800													
Cap	0.010													
μF	0.015													
	0.022													
	0.033	С												
	0.047	C												
	0.068	C												
	0.10	С												
	0.15 0.22													
	0.22			G			\vdash							
	0.33			G										
	0.68			G										
	1.0			G										
	1.5					N								
	2.2					N								
	3.3					N								
	4.7					N	Q		Q*					
	10				_			Q		7				
	22									Z				
	47 100													
	WVDC	6.3	_	6.3	_	4	10	50	100	6.3				
	SIZE	0402		0603		0805	10	1206	100	121				
	JIZE	0402		0003		0000		1200		121	U			
Letter	А	C	Е	G	J	K	М	N	1	Р	Q	X	Υ	
Max.	0.33	0.56	0.71	0.90	0.94	1.02	1.27	1.4		1.52	1.90	2.29	2.54	2.
	(0.013)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.0)		(0.060)	(0.075)	(0.090)	(0.100)	(0.1
Thickness	(0.010)							(0.0		(0.000)				

^{*}Contact Factory for Specifications

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C1608X7R1E334K C2012C0G2A472J 2220J2K00562KXT KHC201E225M76N0T00 1812J2K00332KXT CCR06CG153FSV

CDR14BP471CJUR CDR31BX103AKWR CDR33BX683AKUS CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C

CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H120J CGA2B2C0G1H151J CGA2B2C0G1H1R5C CGA2B2C0G1H2R2C

CGA2B2C0G1H390J CGA2B2C0G1H391J CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2C0G1H820J